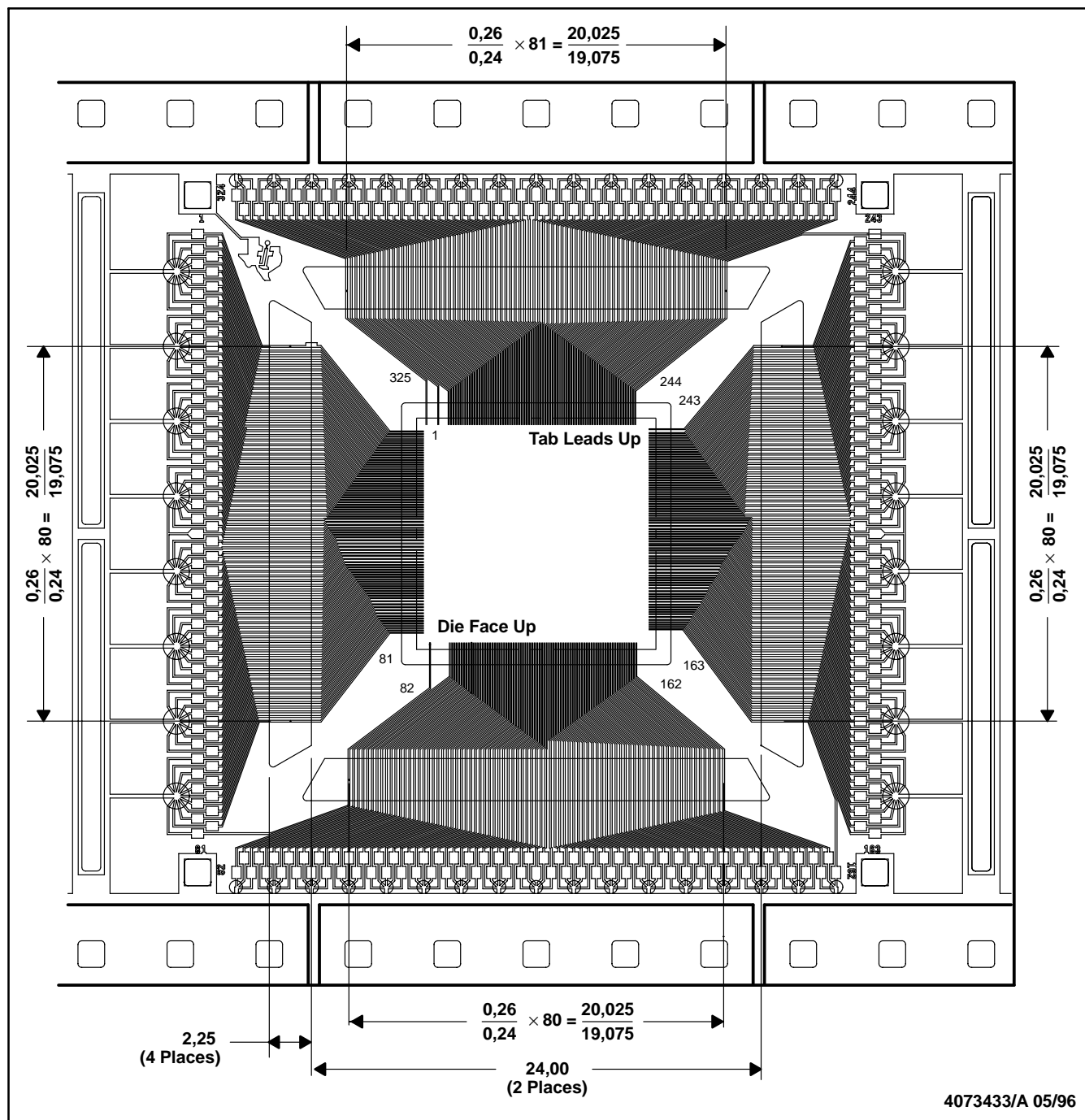


TAB (S-MQCC-F325)  
(48 mm WITH PROTECTIVE FILM)

SMJ320C40 324-PIN TAB FRAME SOCKET (PG 5.1)  
325 OLB/ILB 0,25 mm OLB PITCH



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. The OLB lead width is  $0,10 \pm 0,02$  mm.
  - D. The ILB lead width is  $0,05 \pm 0,01$  mm.
  - E. The tape width is 48 mm.
  - F. The TAB is encapsulated die with polyimide overcoat.

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